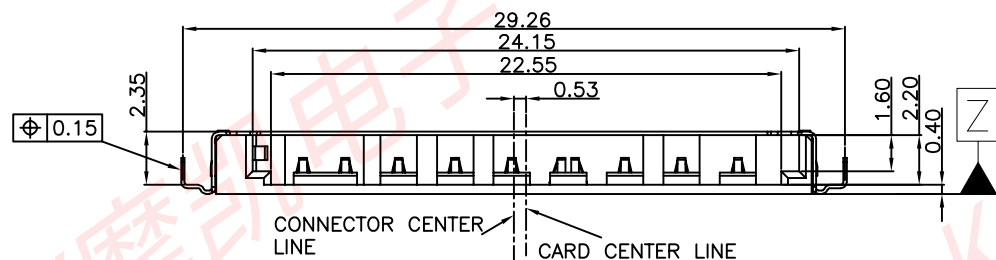
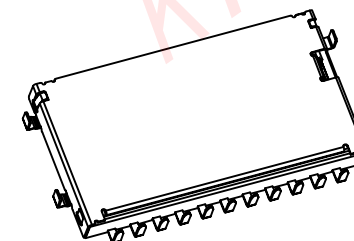
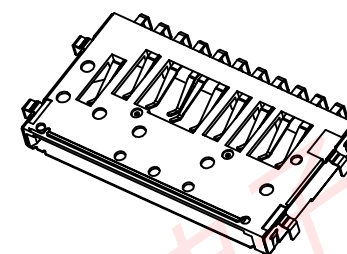
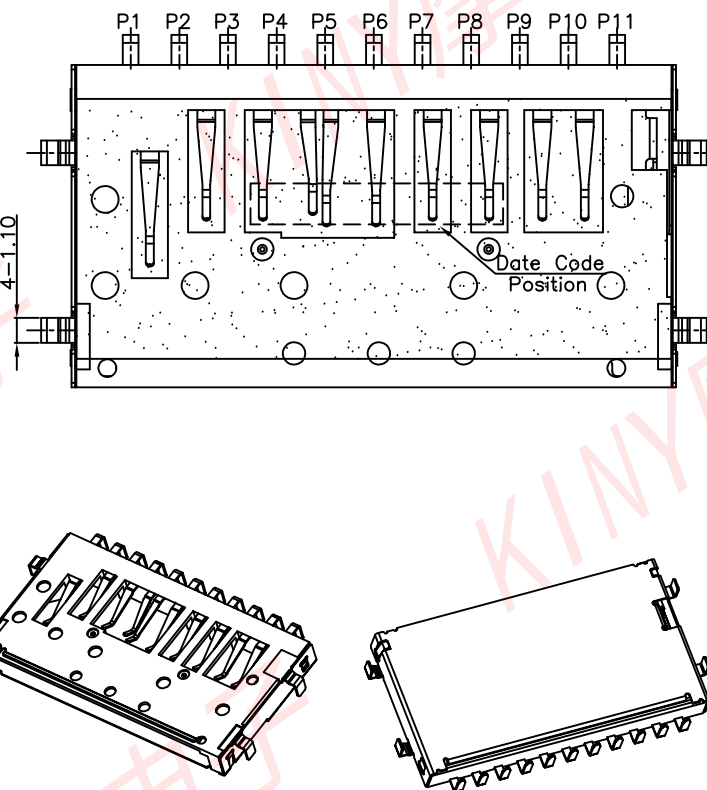
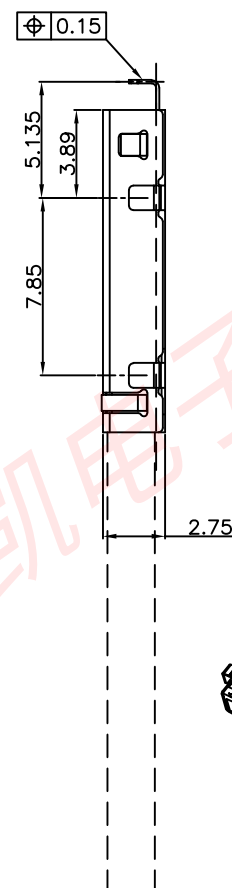
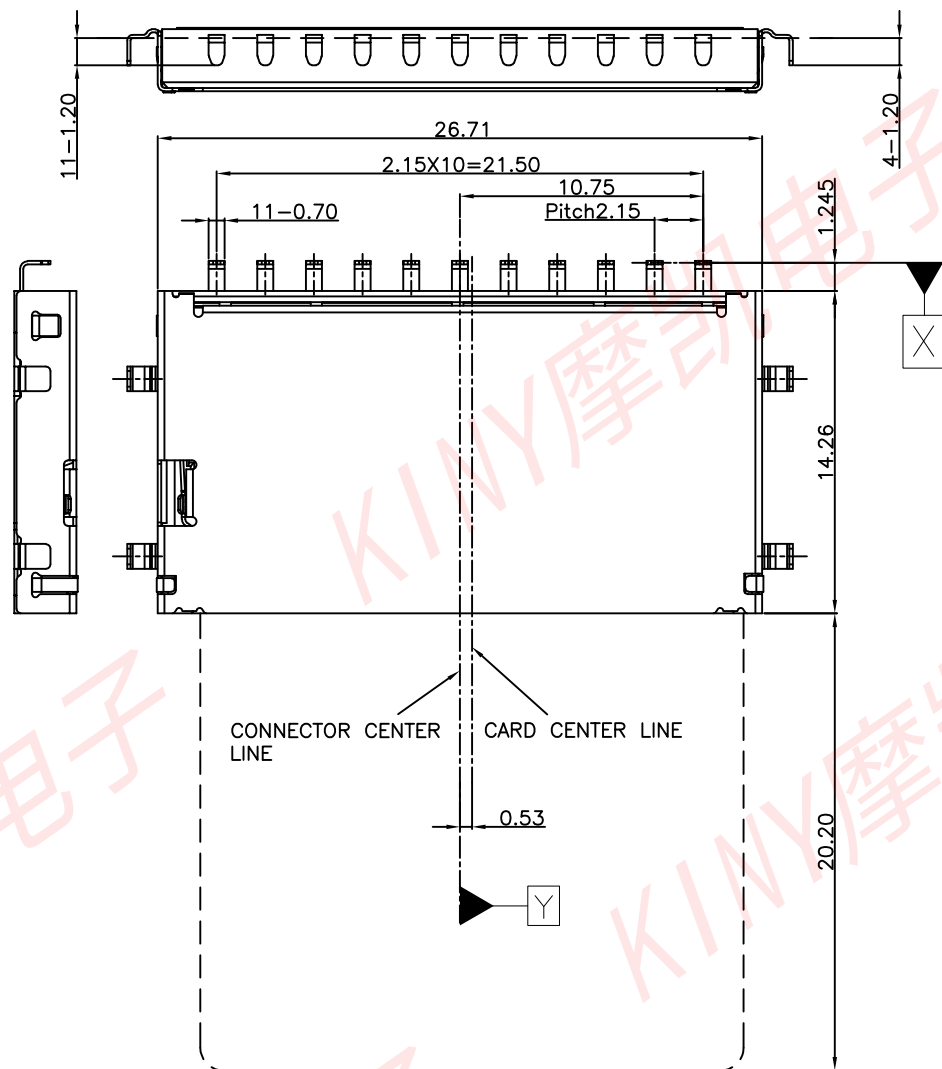


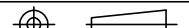
* 所有原料材质, 生产制程, 电镀必须符合HF要求



A	----	NEW RELEASE	janyz	2018.07.17
REVISION NO.	ECR NO.	DESCRIPTION	MARK	DATE

KINY

东莞市摩凯电子有限公司

DIMENSIONS INIT: mm		PRODUCT NAME : SDE-F N/P 板下DIP 沉板 2.35(TS/YD)		DRAWING: Janyz		DATE: 2018.07.17	
UNLESS OTHERWISE SPECIFIABLE		PRODUCT NO. : SDE-D1250-52		CHECK: Alex		DATE: 2018.07.17	
DIMENSION TOLERANCE		DRAWING NO. : D-SDE-D1250-52		APPROVED: Alex		DATE: 2018.07.17	
X.X: ± 0.38				SCALE: 1:1	DWG ID: C D	REV.: A	PAGE: 1 OF 2
X.XX: ± 0.25							
X.XXX: ± 0.10							
ANGULAR: ± 3°							

NOTES :

* 所有原料材质,生产制程,电镀必须符合HF要求

1.Material:

1.1 Insulator:High Temperature Thermoplastic,
(LCP,S475),UL Black 94V-0.

1.2 Contact: Phosphor Bronze(C5191-EH,T=0.15±0.03mm)

1.3 Shell: SUS304-3/4H,T=0.15±0.03mm

2 Plating:

2.1 Contact: Plated 50u"min Ni Overall
Plated 1u"min Au Selective Contact Area
Plated 80u"min Sn over Ni on solder area
2.2 Shell: Plated 50u"min Ni Overall

3.Property:

3.1 Current Rating :0.5A AC/DC
3.2 Voltage Rating :250VRMS
3.3 Dielectric Witshtanding Voltage: AC 500V r.m.s.
3.4 Insulation Resistance:1000MΩ minimum.
3.5 Contact Resistance:100mΩ maximum
3.6 Operating Temperature:-25°C~90°C

4. Part Must Comply Taisol HF WD-3-I-091 Specification.

5. Recommending A Metal More Than 0.15mm Thick. Please
Confirm Solderadility, IF Use A Metal Mask Less Than 0.15mm Thick.

6. Packing Specification NO: P-9A212.

Pin Define

Connector Pin No.	SD Card Pin No.	Pin Define
P1	P9	DAT2
P2	P1	DAT3
P3	P2	CMD
P4		CD
P5	P3	VSS1
P6	P4	VDD
P7	P5	CLK
P8	P6	VSS2
P9	P7	DATO
P10	P8	DAT1
P11		W/P
P12~P15		GND

RECOMMEND P.C.B LAYOUT
(General tolerance ±0.05)

▨ PAD AREA
▤ KEEP OUT AREA
▨ GND PATTERN ONLY

WITHOUT CARD	CARD INSERTED:LOCK	CARD INSERTED:UNLOCK
W/P GND 	W/P GND 	W/P GND
C/D VSS1 P3 	C/D VSS1 P3 	C/D VSS1 P3

KINYY

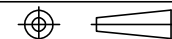
东莞市摩凯电子有限公司

DIMENSIONS INIT: mm
UNLESS OTHERWISE SPECIFIABLE
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X.X: ± 0.38
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PRODUCT NAME :
SDE-F N/P 板下DIP沉板 2.35(TS/YD)

PRODUCT NO. :
SDE-D1250-52

DRAWING NO. :
D-SDE-D1250-52



DRAWING: Janyz DATE: 2018.07.17

CHECK: Alex DATE: 2018.07.17

APPROVED: Alex DATE: 2018.07.17

SCALE: 1:1 DWG ID: C D REV.: A PAGE: 2 OF 2

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